

S. Stevenson  
10-17-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. .... 09/518,511  
Priority Filing Date .... March 3, 2000  
Inventor .... Dinesh Chopra, et al  
Assignee .... Micron Technology, Inc.  
Priority Group Art Unit .... 2825  
Priority Examiner .... L. Malsawma  
Attorney's Docket No. .... MI22-1747  
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and  
Integrated Circuits Formed Thereby

LETTER SUBMITTING FORMAL DRAWINGS

Assistant Commissioner for Patents  
Attention: Official Draftsman  
Washington, D.C. 20231


Please enter the enclosed formal drawings in the above-referenced application  
in place of drawings originally filed.

Acknowledgment of receipt of the formal drawings and their acceptance into the  
file is requested.

Respectfully submitted,

Date: 13 Jun 2001

By:

  
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Reg. No.: 44,854  
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Enclosures: Four (4) Sheets of Formal Drawings (Figs. 1-12)